

LCD MODULE SPECIFICATION

Model: MACHMI0686BT-1CP

This module is ROHS compliant

For Customer's Acceptance:

Customer	
Approved by	
Comment	

■ REVISION RECORD

[illegible]

CONTENTS

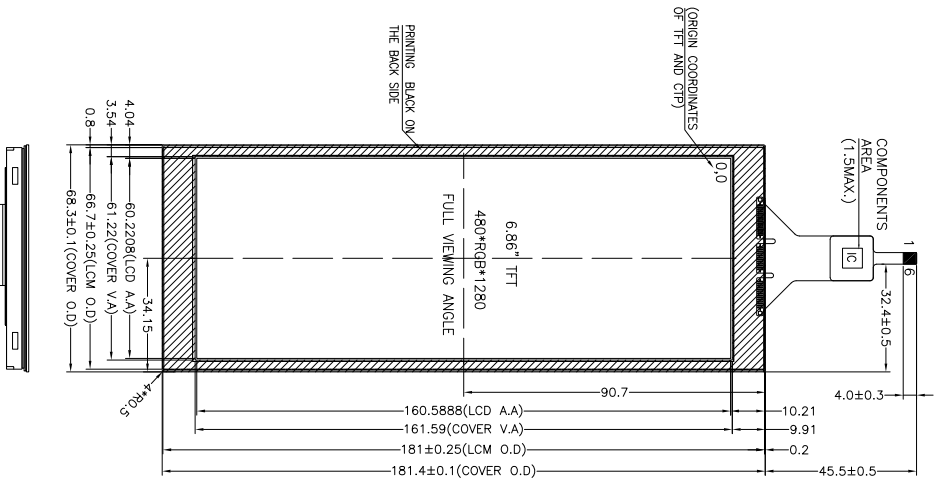
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■ GENERAL INFORMATION

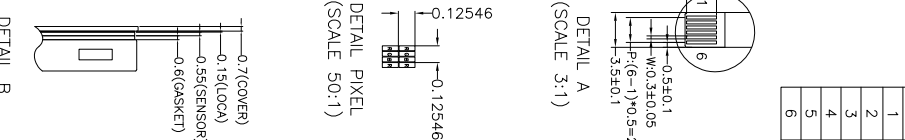
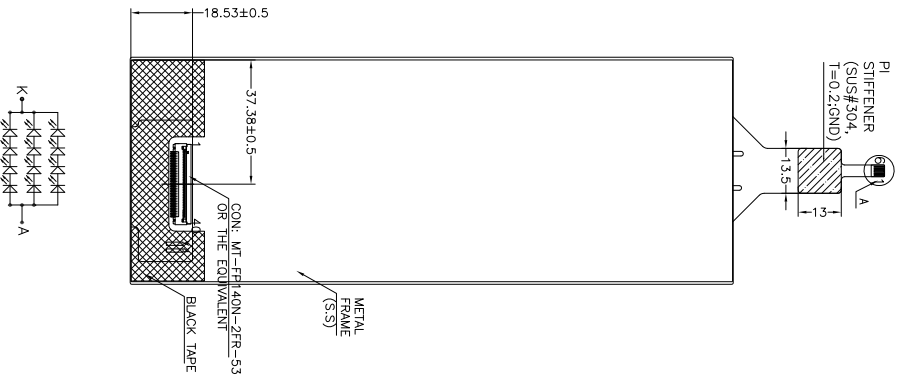
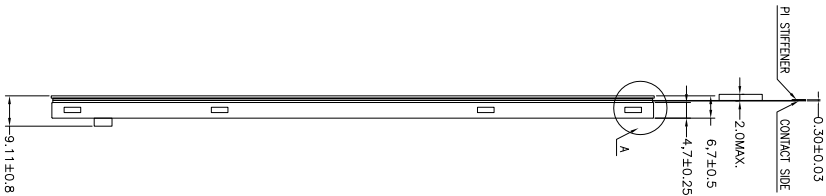
Item	Specification	Unit
LCD Type	IPS TFT / Transmissive / Normally Black	/
Size	6.86	Inch
Viewing Direction	Full Viewing Angle	O'clock
Gray Scale Inversion Direction	-	O'clock
LCM (W × H × D)	68.30 × 181.40 × 6.70	mm ³
Active Area (W × H)	60.22 × 160.59	mm ²
Pixel Pitch	0.12546 × 0.12546	mm ²
Number of Dots	480 (RGB) × 1280	/
Driver IC	HX8394F	/
Backlight Type	12LEDs	/
Interface Type	4-lane MIPI	/
Color Depth	16.7M	/
Pixel Configuration	R.G.B Vertical Stripe	/
Top Polarizer Surface Treatment	Anti-glare	/
Input Voltage	3.3	V
With / Without TSP	With CTP	/
TP Surface Treatment	Glare	/
Weight	TBD	g

Note 1: ROHS compliant;

Note 2: LCM weight tolerance: ±10%.



- NOTES FOR TFT:
1. DISPLAY TYPE: TFT / TRANSMISSIVE / NORMALLY BLACK
 2. OPERATING VOLTAGE: VDD=3.3V
 3. VIEWING DIRECTION: FULL VIEWING ANGLE
 4. DRIVER IC: HX8394F
 5. BACKLIGHT: 12-CHIP WHITE LED, IF=120mA, VF=11.2V~13.2V
 6. TREATMENT OF TOP SURFACE: ANTI-GLARE
- OTHERS:
1. OPERATING TEMP.: -20°C~70°C
 2. STORAGE TEMP.: -30°C~80°C
 3. SURFACE LUMINANCE: 500CD/M²(TYP.)(WITH CTP)
 4. GENERAL TOLERANCE: ±0.3mm
 5. ROHS COMPLIANT



PIN ASSIGNMENT FOR CTP		PIN ASSIGNMENT FOR LCM	
PIN	SYMBOL	PIN	SYMBOL
1	RST	2	DOP
2	VCC	3	DON
3	GND	4	INT
4	INT	5	DIP
5	SDA	6	DIN
6	SCL	7	GND
		8	CLKP
		9	CLKN
		10	GND
		11	D2P
		12	D2N
		13	GND
		14	D3P
		15	D3N
		16	GND
		17	GND
		18	VDDIO
		19	VDDIO
		20	REFCLK
		21	SDA
		22	SCL
		23	IRQ
		24	RSTB
		25	STRB
		26	NC
		27	GND
		28	K
		29	K
		30	GND
		31	NC
		32	GND
		33	GND
		34	NC
		35	A
		36	A
		37	GND
		38	VDD
		39	VDD
		40	NC

BACKLIGHT CIRCUIT DIAGRAM

DETAIL B (SCALE 2:1)

DETAIL A (SCALE 3:1)

DETAIL PIXEL (SCALE 50:1)

- NOTES FOR CTP:
1. 6.86 INCH PROJECTIVE CAPACITIVE TOUCH PANEL
 2. COVER GLASS + SENSOR GLASS + FPCA
 3. OPERATING VOLTAGE: VCC=3.3V
 4. DRIVER IC: G1911
 5. INTERFACE: I²C
 6. RESOLUTION: 480*1280
 7. MULTI FINGER: UP TO 5
 8. HARDNESS OF COVER SURFACE: >=6H
 9. FIRMWARE FILE: TBD

01	FIRST ISSUE	RITA	2021.12.09	VERSION NO.: 01	DRAWN BY: RITA	2021.12.09	CHECKED BY: RITA	SCALE: 1/1	UNIT: mm	DESCRIPTION: TFT + CTP MODULE
VER.	REVISED DESCRIPTION	REVISER	DATE	VERSION NO.	SHEET NO.: 1/1					

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage for Analog	VDD	-0.3	3.6	V
Supply Voltage for Logic	VDDIO	-0.3	3.6	V
Supply Current (One LED)	I _{LED}	-	30	mA
Operating Temperature	T _{OP}	-20	70	°C
Storage Temperature	T _{ST}	-30	80	°C

■ ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Supply Voltage for Analog	VDD	2.5	3.3	3.6	V	
Supply Voltage for Logic	VDDIO	1.65	1.8/3.3	3.6	V	
Input High-Level Voltage	V _{IH}	0.7VDDIO	-	VDDIO	V	
Input Low-Level Voltage	V _{IL}	GND	-	0.3VDDIO	V	
Input Leakage Current	I _{LKG}	-1	-	1	μA	

■ BACKLIGHT CHARACTERISTICS

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Forward Voltage	V _f	11.2	12.0	13.2	V	T _a =25±2°C, 60%RH±5%
Forward Current	I _f	-	120	-	mA	
Power Consumption	W _{BL}	-	1440	-	mW	
Operating Life Time	-	30000	-	-	Hrs.	

Note: Operating life time means brightness goes down to 50% initial brightness;

The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions.

■ ELECTRO-OPTICAL CHARACTERISTICS

Ta=25°C±2°C. VDD=3.3V, If=120mA.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark	Notes
Response Time	Tr + Tf	$\theta=0^\circ$ $\phi=0^\circ$ Ta=25°C	-	25	35	ms	FIG 1, 2	4
Contrast Ratio	Cr		1000	1500	-	---	FIG 1, 3	1
Luminance Uniformity	δ White		80	-	-	%	FIG 1, 3	3
Surface Luminance	Lv		400	500	-	cd/m ²	FIG 1, 3	2
Viewing Range Angle	θ	$\phi = 90^\circ$	80	-	-	deg	FIG 1, 4	1, 6
		$\phi = 270^\circ$	80	-	-	deg		
		$\phi = 0^\circ$	80	-	-	deg		
		$\phi = 180^\circ$	80	-	-	deg		
CIE (x,y) Chromaticity	Red	x	0.587	0.637	0.687	---	FIG 1, 3	5
		y	0.291	0.341	0.391			
	Green	x	0.245	0.295	0.345			
		y	0.538	0.588	0.638			
	Blue	x	0.091	0.141	0.191			
		y	0.031	0.081	0.131			
	White	x	0.221	0.271	0.321			
		y	0.239	0.289	0.339			
NTSC	-	-	-	66.8	-	%	-	-

Note 1. Contrast Ratio (CR) is defined by following formula. For more information see FIG 3.

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)}}$$

Note 2. Surface luminance is the LCD surface luminance with all pixels displaying white state. For more information see FIG 3.

$$Lv = \text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}$$

Note 3. The uniformity in surface luminance (δ White) is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 3.

$$\delta \text{ White} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}$$

Note 4. Response time is the time required for the display to transition from white to black (Rise Time, Tr) and from black to white (Fall Time, Tf). For additional information see FIG 2.

Note 5. CIE (x,y) chromaticity, color coordinates measured at center point of LCD.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than a specific value. For TFT module the contrast ratio is greater than 10. The monochrome LCD, the specific value of contrast ratio is 2. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 4.

Note 7. For viewing angle and response time testing, the testing data is based on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface luminance, Luminance uniformity, and CIE, the test data is based on TOPCON's BM-5 photo detector.

FIG 1. The setup of optical measurement.

The optical characteristics should be measured in a stable, windless, and dark room.

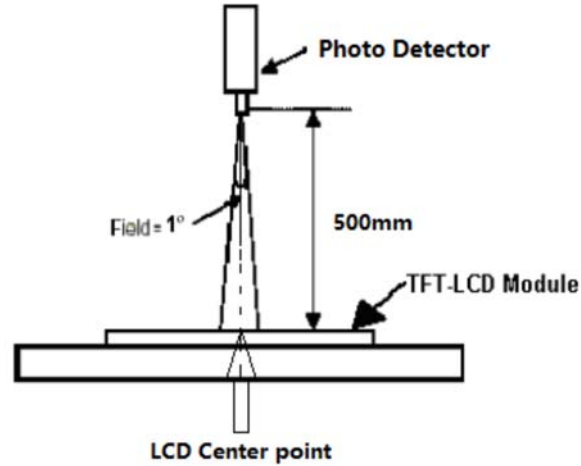


FIG 2. The Definition of Response Time

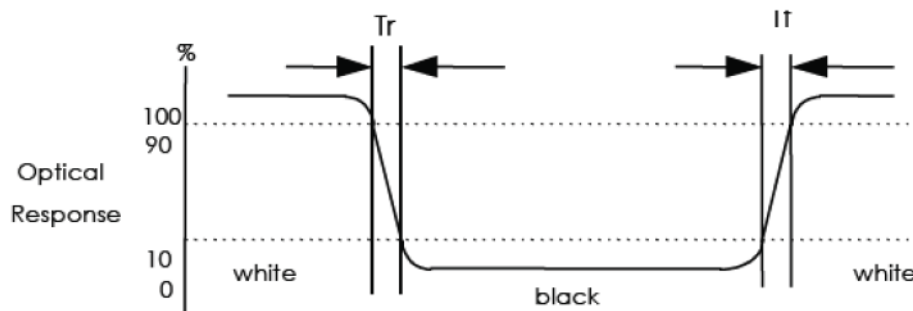
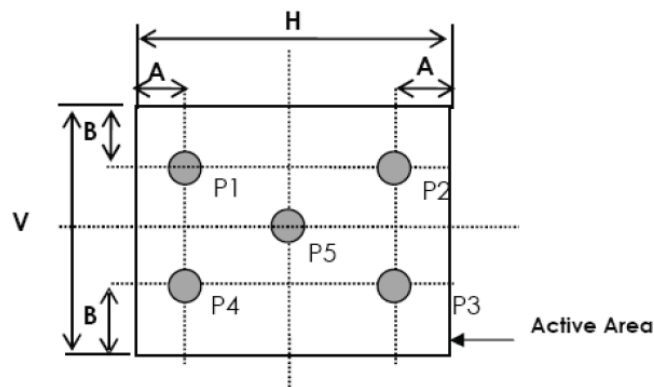


FIG 3. Measuring method for contrast ratio, surface luminance, Luminance uniformity, CIE (x,y) chromaticity.



A: $H/6$

B: $V/6$

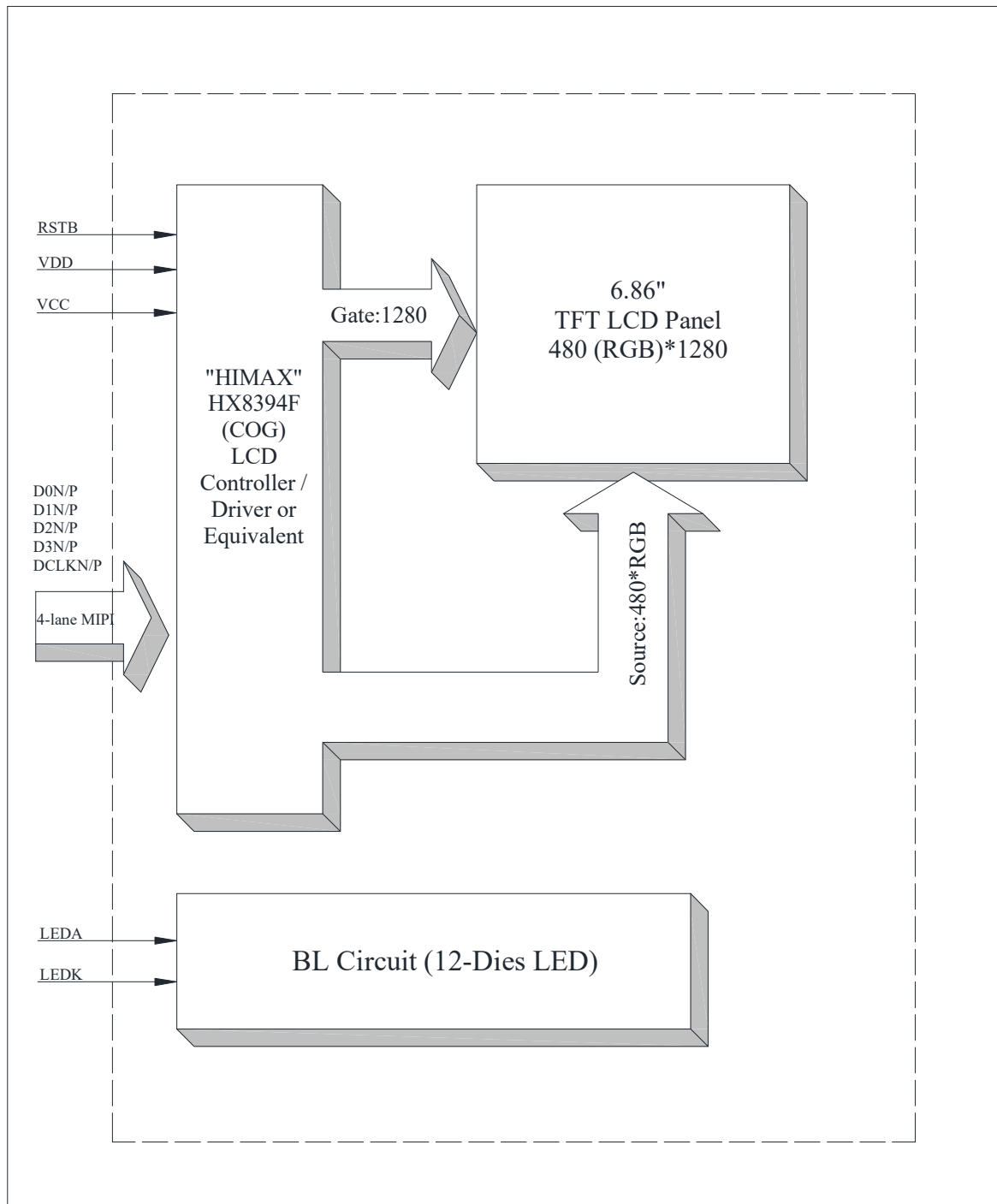
H, V: Active Area

Light spot size $\varnothing = 7\text{mm}$, 500mm distance from the LCD surface to detector lens.

Measurement instrument is TOPCON's luminance meter BM-5.

■ INTERFACE DESCRIPTION

Pin No.	Symbol	Description
1	GND	Ground.
2	D0P	MIPI data positive signal (D0+).
3	D0N	MIPI data negative signal (D0-).
4	GND	Ground.
5	D1P	MIPI data positive signal (D1+).
6	D1N	MIPI data negative signal (D1-).
7	GND	Ground.
8	CLKP	MIPI data positive signal (CLK+).
9	CLKN	MIPI data negative signal (CLK-).
10	GND	Ground.
11	D2P	MIPI data positive signal (D2+).
12	D2N	MIPI data negative signal (D2-).
13	GND	Ground.
14	D3P	MIPI data positive signal (D3+).
15	D3N	MIPI data negative signal (D3-).
16	GND	Ground.
17	GND	Ground.
18	VDDIO	Power supply for logic.
19	VDDIO	Power supply for logic.
20	REFCLK	No connection.
21	SDA	No connection.
22	SCL	No connection.
23	IRQ	No connection.
24	RSTB	Chip reset pin, low active.
25	STBYB	No connection.
26	NC	No connection.
27	GND	Ground.
28	K	Cathode of backlight.
29	K	Cathode of backlight.
30	GND	Ground
31	NC	No connection.
32	GND	Ground
33	GND	Ground
34	NC	No connection.
35	A	Anode of backlight.
36	A	Anode of backlight.
37	GND	Ground
38	VDD	Power supply for analog.
39	VDD	Power supply for analog.
40	NC	No connection.



■ APPLICATION NOTES

■ CTP SPECIFICATIONS

1. GENERAL SPECIFICATIONS

Item	Specification	Unit
Type	Projective capacitive type touch panel	/
Structure	Cover glass + Sensor glass + FPCA	/
Input Mode	Human's finger	/
Finger	Up to 5	/
Resolution	480 × 1280	dots
Cover Viewing Area	61.22(W) × 161.59(H)	mm
Hardness	6H	Pencil hardness
Driver IC	GT911	/

2. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Supply Voltage	VCC	2.8	3.3	3.6	V	
Supply Current	ICC	-	TBD	-	mA	
Input Voltage 'H' Level	VIH	0.7VCC	-	VCC	V	
Input Voltage 'L' Level	VIL	-0.3	-	0.3VCC	V	
Output Voltage 'H' Level	VOH	0.7VCC	-	-	V	
Output Voltage 'L' Level	VOL	-	-	0.7VCC	V	

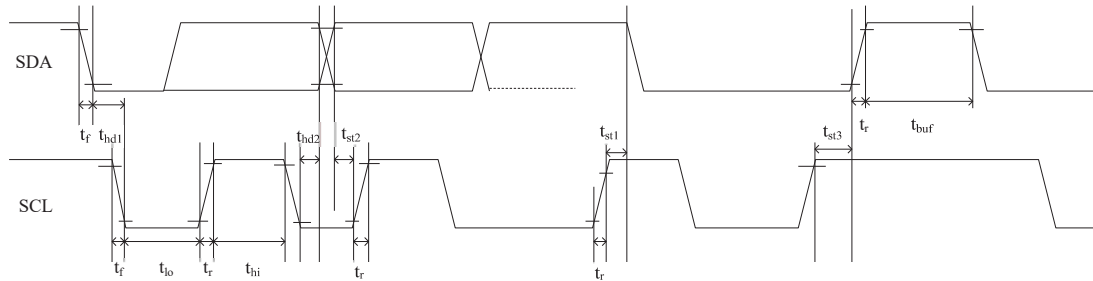
3. PIN CONNECTIONS

No.	Name	Type	Description
1	RST	I	Reset. Active low.
2	VCC	P	Power supply.
3	GND	P	Ground.
4	/INT	O	Interrupt signal to host from CTP.
5	SDA	I/O	I ² C data signal.
6	SCL	I	I ² C clock input.

4. CTP TIMING

I2C Communication

GT911 provides standard I2C interface for communication. In the system, GT911 always works in slave mode, all communications are initiated by master, and the baud rate can be up to 400K bps. The definition of I2C timing is as following:



Test condition1: 1.8V communication interface, 400Kbps, pull up resistor is 2K ohm

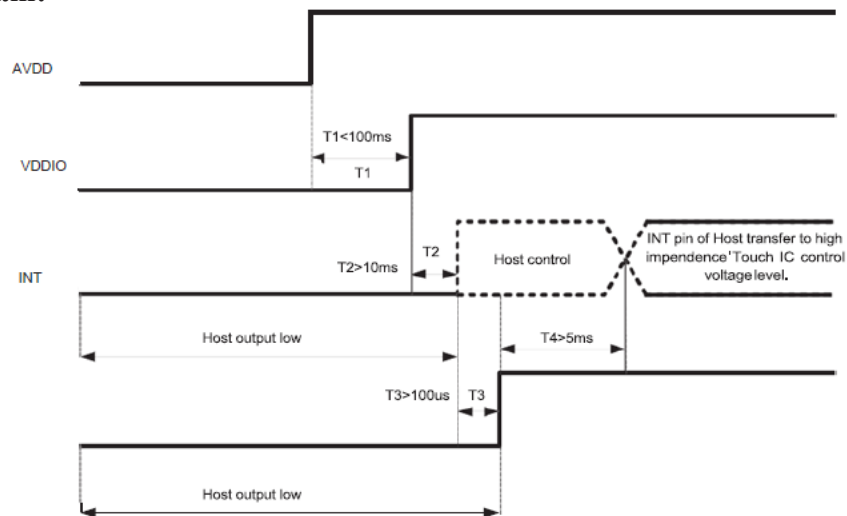
Parameter	Symbol	MIN.	Max.	Unit
SCL low period	t _{lo}	0.9	-	us
SCL high period	t _{hi}	0.8	-	us
SCL setup time for START condition	t _{st1}	0.4	-	us
SCL setup time for STOP condition	t _{st3}	0.4	-	us
SCL hold time for START condition	t _{hd1}	0.3	-	us
SDA setup time	t _{st2}	0.4	-	us
SDA hold time	t _{hd2}	0.4	-	us

Test condition2: 3.3V communication interface, 400Kbps, pull up resistor is 2K ohm

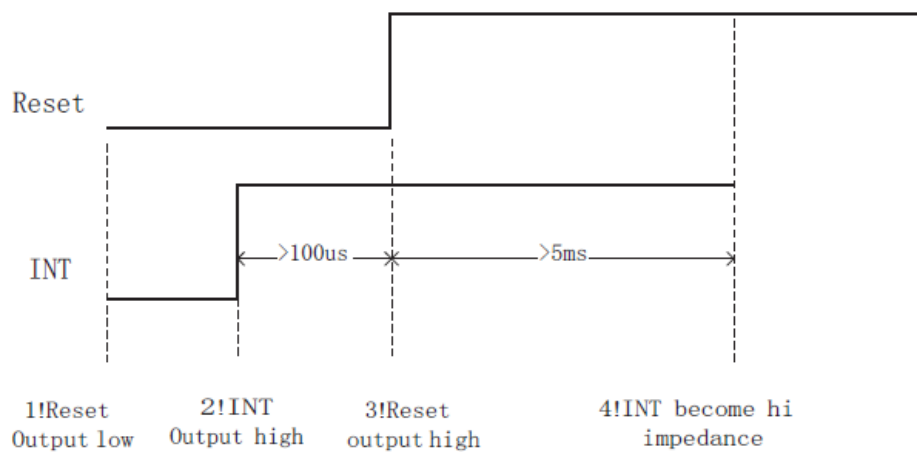
Parameter	Symbol	MIN.	Max.	Unit
SCL low period	t _{lo}	0.9	-	us
SCL high period	t _{hi}	0.8	-	us
SCL setup time for START condition	t _{st1}	0.4	-	us
SCL setup time for STOP condition	t _{st3}	0.4	-	us
SCL hold time for START condition	t _{hd1}	0.3	-	us
SDA setup time	t _{st2}	0.4	-	us
SDA hold time	t _{hd2}	0.4	-	us

GT911 has 2 sets of slave address 0xBA/0xBB & 0x28/29. Master can control Reset & INT pin to configure the slave address in power on initial state like.

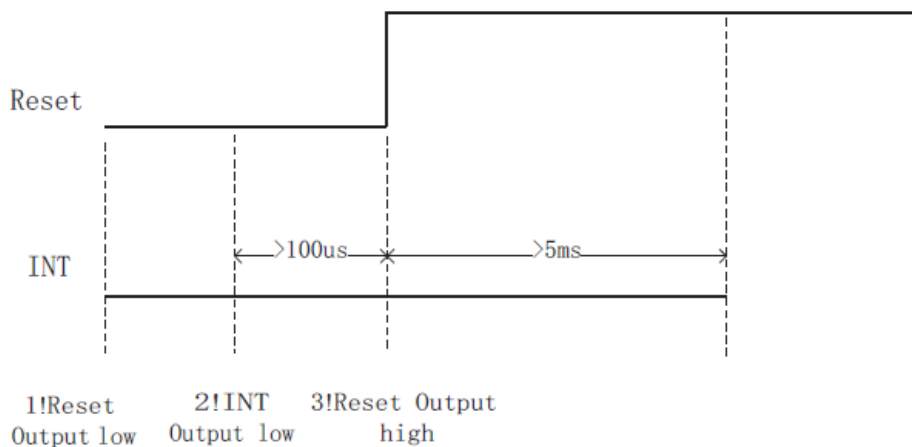
**Following:
Power on diagram:**



Timing of setting slave address to 0x28/0x29:



Timing of setting slave address to 0xBA/0xBB:



a) Data Transmission

(ex: slave address is 0xBA/0xBB)

Communication is always initiated by master, A high-to-low transition of SDA with SCL high is a start condition.

All addressing signal are serially transmitted to and from on bus in 8-bit word.

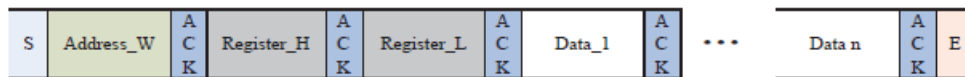
*7911 VHQGV D³. ' WR DFNQRZOHGJH ZKHQ WKH DGGUHV Ving word is 0xBA/BB (or 0x28/0x29). This happens during the ninth clock cycle. If the slave address is not matched, GT911 will stay in idle state.

The data words are serially transmitted to and from in 9-bit formation: 8-bit data + 1-bit ACK or NACK sent by GT911. Data changes during SCL low periods & keeps valid during SCL high.

A low-to-high transition of SDA with SCL high is a stop condition.

b) Write Data to GT911

(ex: slave address is 0xBA/0xBB)

**Write operations**

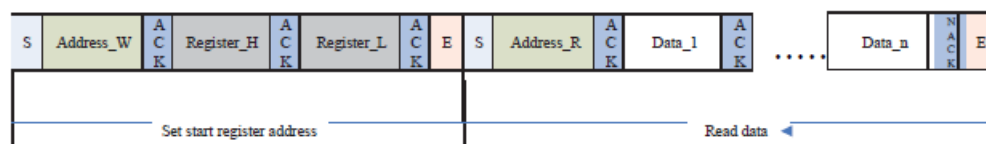
Please check the above figure, master start the communication first, and then sends device address 0xBA preparing for a write operation.

After receiving ACK from GT911, master sends out 16-bit register address, and then the data word in 8-bit, which is going to be wrote into GT911.

The address pointer of GT911 will automatically increase one after one byte writing, so master can sequentially write in one operation. When operation finished, master stop the communication.

c) Read Data from GT911

(ex: slave address is 0xBA/0xBB)

**Read operations**

Please check the above figure, master start the communication first, and then sends device address 0xBA for a write operation. After receiving ACK from GT911, master sends out 16-bit register address, To set the address pointer of GT911. After receiving ACK, master produce start signal once again & send device address 0xBB, then read data word from GT911 in 8bit. GT911 also supports sequential read operation, and the default setting is sequential read mode. Master shall send out ACK after every byte reading successfully but NACK after the last one. Then sends stop signal to finish the communication.

Note: More information pls refer to IC spec.

■ RELIABILITY TEST

No.	Test Item	Test Condition	Remark
1	High Temperature Storage Test	80°C ± 2°C / 240Hrs.	IEC60068-2-2 GB2423.2
2	Low Temperature Storage Test	-30°C ± 2°C / 240Hrs.	IEC60068-2-1 GB2423.1
3	High Temperature Operating Test	70°C ± 2°C / 240Hrs.	IEC60068-2-2 GB2423.2
4	Low Temperature Operating Test	-20°C ± 2°C / 240Hrs.	IEC60068-2-1 GB2423.1
5	High Temperature and High Humidity Operation Test	60 ± 5°C, 90%RH 240Hrs.	IEC60068-2-3 GB/T2423.3
6	Thermal Shock Test (Non-operating)	-30±2°C(30Min.) ~25±2°C(5Min.) ~80±2°C(30Min.) 20Cycles	IEC60068-2-14 GB2423.22
7	Vibration Test (Non-operating)	Frequency: 10~55Hz Amplitude: 1.5mm Sweep Time: 11Mins Test Period: 6 Cycles for Each Direction of X, Y, Z (Packing Condition)	IEC60068-2-6 GB2423.10
8	Shock Test (Non-operating)	100G, 6Ms Direction: ±X, ±Y, ±Z Cycle: 3 Times	IEC60068-2-27 GB/T2423.5
9	Electro Static Discharge Test	R: 330Ω, C:150pF, 5points/panel Air: ±8KV, 5times; Contact: ±4KV, 5times; (Environment: 15°C~35°C, 30%~60%, 86Kpa~106Kpa)	IEC61000-4-2 GB/T17626.2

Note 1: Without water condensation.

Note 2: The function test shall be conducted after 2 hours storage at the room temperature (25°C±2°C) and room humidity (65%±5%) after removed from the test chamber. In the standard conditions, there shall be no functional defects occurred.

■ INSPECTION CRITERION

OUTGOING QUALITY STANDARD	PAGE 1 OF 4
TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for TFT module.

1. Sample Plan

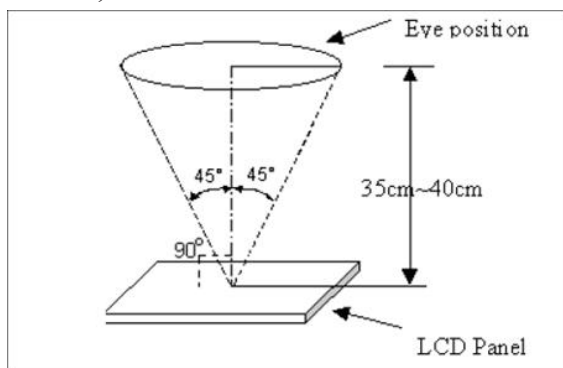
- 1.1 Lot size: Quantity per shipment lot per model
- 1.2 Sampling type: Normal inspection, Single sampling
- 1.3 Inspection level: II
- 1.4 Sampling table: MIL-STD-105D
- 1.5 Acceptable quality level (AQL)
 - Major defect: AQL=0.65
 - Minor defect: AQL=1.50

2. Inspection Condition

- 2.1 Ambient conditions
 - a. Temperature: Room temperature $25\pm 5^{\circ}\text{C}$
 - b. Humidity: $(60\pm 10)\% \text{RH}$
 - c. Illumination: Single fluorescent lamp non-directive (300 to 700 Lux)
- 2.2 Viewing distance

The distance between the LCD and the inspector's eyes shall be at least $35\pm 5\text{cm}$.
- 2.3 Viewing angle

U/D: $45^{\circ} / 45^{\circ}$, L/R: $45^{\circ} / 45^{\circ}$



3. Definition of Inspection Item

- 3.1 Definition of inspection zone in LCD module (LCM)

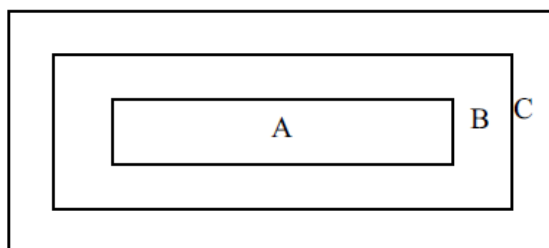
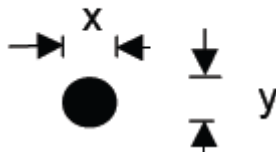
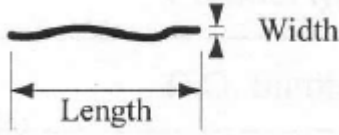

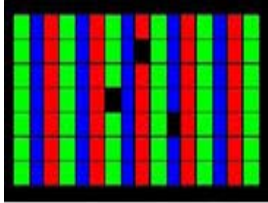
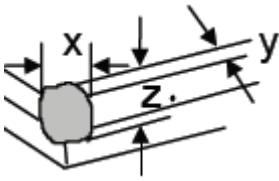
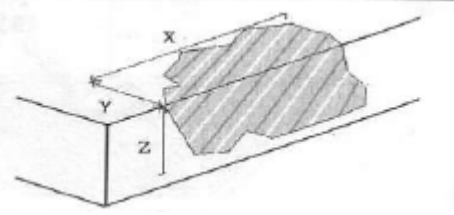


Fig.1 Inspection zones in an LCD

- Zone A: Character / Digit area (Active area)
- Zone B: Viewing area except Zone A (Zone A + Zone B=minimum viewing area)
- Zone C: Outside viewing area (invisible area after assembly in customer's product)

OUTGOING QUALITY STANDARD		PAGE 2 OF 4	
TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA			
<p>Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer’s product. If any visual defect in Zone C is impermissible, customers need to inform us by written.</p>			
4. Inspection Plan			
Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.			
4.1 Major defect			
Item No.	Items To Be Inspected	Inspection Standard	
4.1.1	All Functional Defects	1) No display 2) Display abnormally 3) Short circuit 4) Line defect 5) Excess power consumption	
4.1.2	Missing	Missing function component	
4.1.3	Crack	Glass crack	
4.2 Minor defect			
Item No.	Items To Be Inspected	Inspection Standard	
4.2.1	Spot Defect Including Black spot White spot Pinhole Foreign particle Polarizer dirt	For dark / white spot is defined $\varphi = (x + y) / 2$ 	
		Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.25$ 2mm(min) apart	Ignore
		$0.25 < \varphi \leq 0.50$ 5mm(min) apart	5
		$0.50 < \varphi$	Not allowed

OUTGOING QUALITY STANDARD		PAGE 3 OF 4	
TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA			
4.2.2	Line Defect Including Black line White line Scratch	Defined	
			
		Width (mm) Length (mm)	Acceptable Quantity
		$W \leq 0.05$ and $L \leq 10$	Ignore
		$0.05 < W \leq 0.08$ and $L \leq 10$ 5mm(min) apart	5
		$0.08 < W \leq 0.10$ and $L \leq 5$ 5mm(min) apart	3
		$0.10 < W$ or $10 < L$	Not allowed
4.2.3	Polarizer Dent / Bubble	Size ϕ (mm)	Acceptable Quantity
		$\phi \leq 0.30$	Ignore
		Non visible area	Ignore
		$0.30 < \phi \leq 0.50$ 5mm(min) apart	5
		$0.50 < \phi$	Not allowed
4.2.4	Electrical Dot Defect	Bright and black dot define:	
		 and 	
		Inspection pattern: Full white, Full black, Red, Green and Blue screens	
		Item	Acceptable Quantity
		Black dot defect	5
		Bright dot defect	2
		Total Dot	5

OUTGOING QUALITY STANDARD		PAGE 4 OF 4
TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA		
4.2.5	Touch Panel Chips	1. Corner chips: 
		Size (mm)
		Acceptable Quantity
		Ignore T: Glass thickness X: Length Y: Width Z: Thickness
		2. Side chips: 
		Size (mm)
		Acceptable Quantity
		Ignore T: Glass thickness X: Length Y: Width Z: Thickness
4.2.6	Touch Panel Newton Ring	Compare with limit sample

- Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.
 2. The distance between black dot defects or black and bright dot defects should be more than 5mm apart. The distance between two bright dot defects should be more than 15mm apart.
 3. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.
 4. Mura is checker by 6% ND filter.
 5. Foreign particle on the surface of the LCM should be ignore.

■ PRECAUTIONS FOR USING LCD MODULES

◆ Handling Precautions

1. The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
2. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in contact with room temperature air.
5. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents.
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

6. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
7. Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.
8. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
9. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
10. Do not attempt to disassemble or process the LCD module.
11. If the logic circuit power is off, do not apply the input signals.
12. Electro-Static Discharge Control. Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
13. Electro-Static Discharge Control. Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

- Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

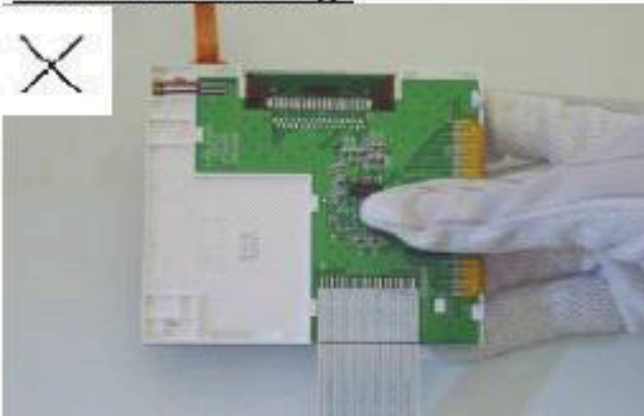
- Do not drop, bend or twist LCM.

◆ Handling Precaution for LCM

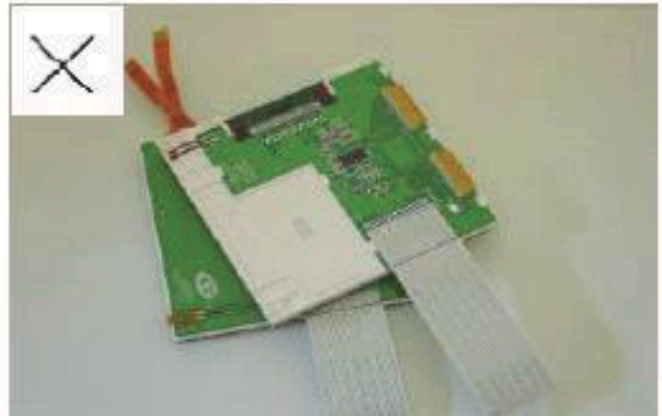
LCM is easy to be damaged.
Please note below and be careful for handling!

Correct handling:

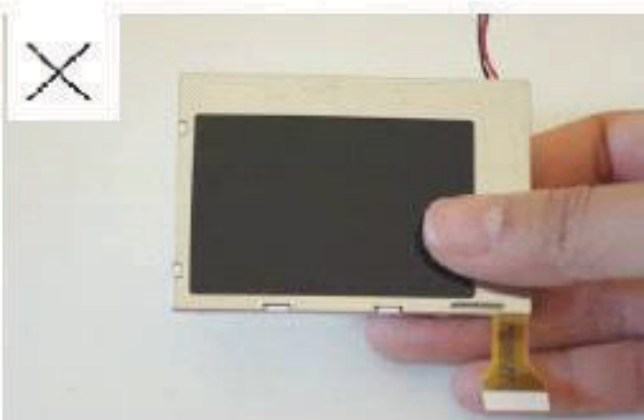
As above picture, please handle with anti-static gloves around LCM edges.

Incorrect handling:

Please don't touch IC directly.



Please don't stack LCM.



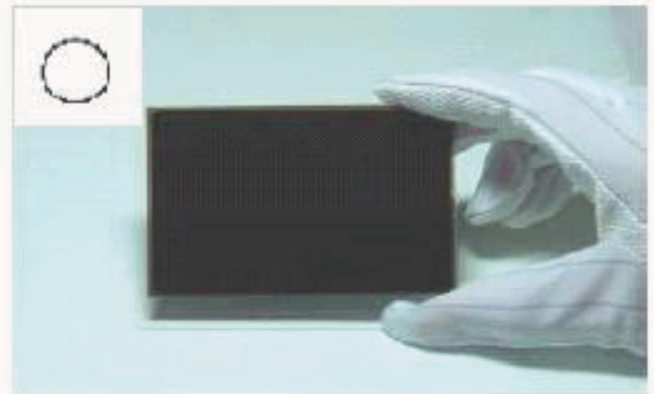
Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.

◆ Handling Precaution for LCD

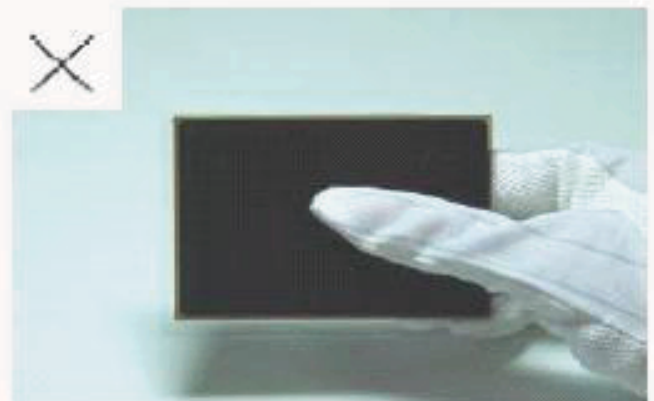
LCD is easy to be damaged.
Please note below and be careful for handling!

Correct handling:

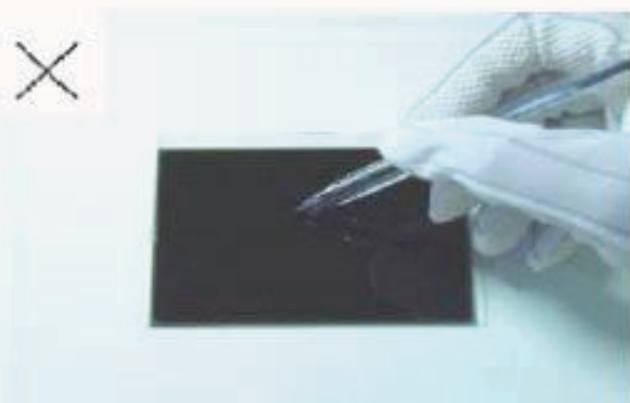
As above photo, please handle with anti-static gloves around LCD edges.

Incorrect handling:

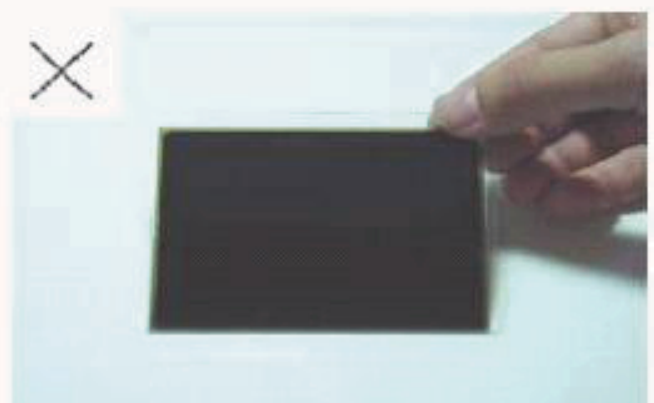
Please don't stack the LCDS.



Please don't hold the surface of LCD.



Please don't operate with sharp stick such as pens.



Please don't touch ITO glass without anti-static gloves.

◆ Storage Precautions

When storing the LCD modules, the following precaution is necessary.

1. Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
2. Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
3. The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped.

◆ Others

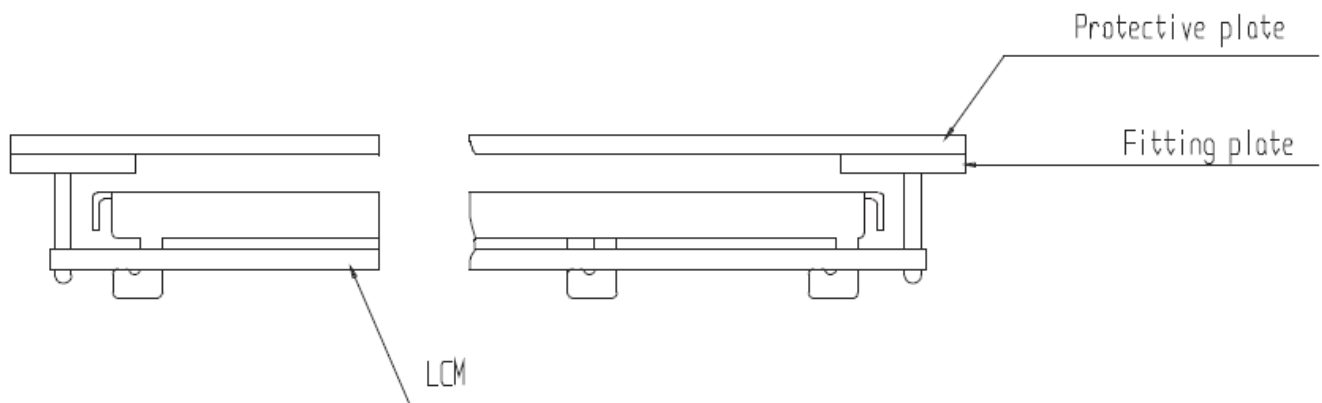
1. Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
2. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
3. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - Exposed area of the printed circuit board.
 - Terminal electrode sections.

◆ Using LCD Modules

1. Installing LCD Modules

1.1 The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

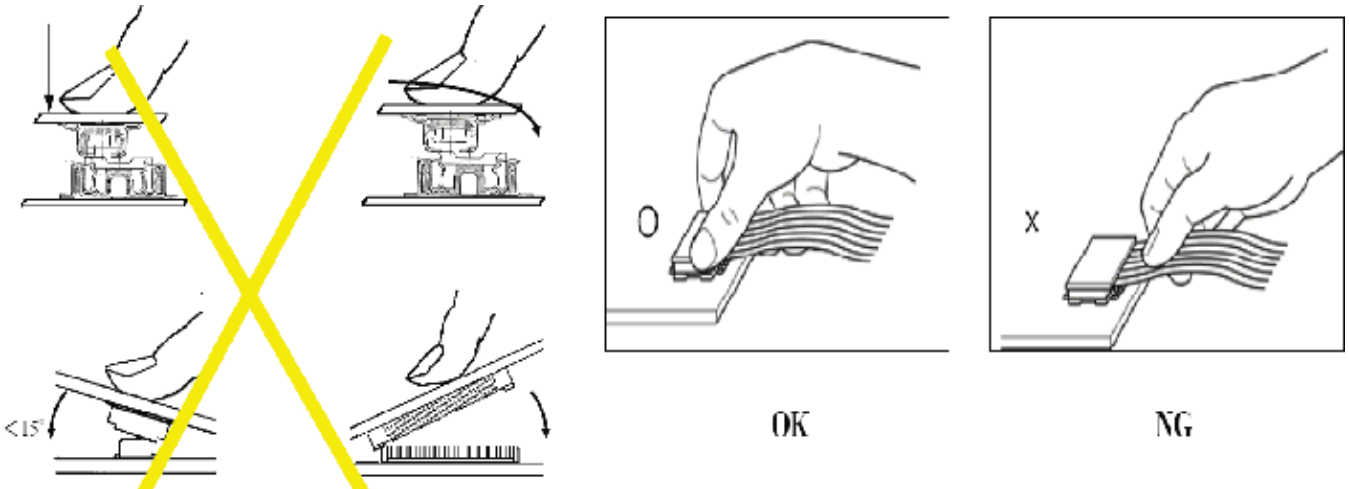
1.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



1.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be $\pm 0.1\text{mm}$.

2. Precaution For Assemble The Module With BTB Connector

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows.



◆ Precaution For Soldering To The LCM

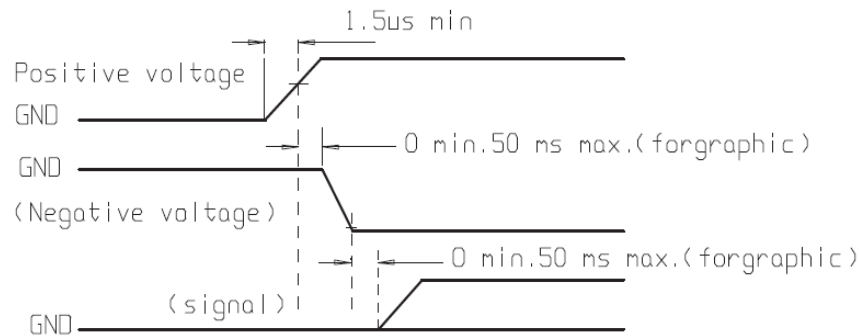
	Hand Soldering	Machine Drag Soldering	Machine Press Soldering
No ROHS Product	290°C ~ 350°C. Time: 3~5S.	330°C ± 350°C. Speed: 4~8mm/s.	300°C ± 330°C. Time: 3~6S. Press: 0.8~1.2Mpa
ROHS Product	340°C ~ 370°C. Time: 3~5S.	350°C ± 370°C. Speed: 4~8mm/s.	330°C ± 360°C. Time: 3~6S. Press: 0.8~1.2Mpa

1. If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
2. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
3. When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

◆ Precaution For Operation

1. Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
2. It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
3. Response time will be extremely delayed at lower temperature than the operating temperature range and on the mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature.
4. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
5. A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
6. Input each signal after the positive/negative voltage becomes stable.

7. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.



◆ Safety

1. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
2. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

◆ Limited Warranty

Unless agreed between manufacturer and customer, manufacturer will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with manufacturer LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to manufacturer within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability is limited to repair and/or replacement on the terms set forth above. manufacturer will not be responsible for any subsequent or consequential events.

◆ Return LCM Under Warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PRIOR CONSULT MATTER

1. For manufacturer standard products, we keep the right to change material, process ... for improving the product property without notice on our customer.
2. For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
3. If you have special requirement about reliability condition, please let us know before you start the test on our samples.